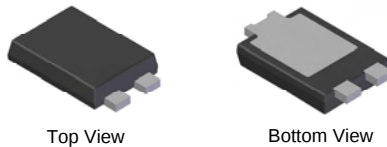


Features

- Guard Ring Die Construction for Transient Protection
- Very Low Forward Voltage Drop
- High Forward Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Qualified to AEC-Q101 Standards for High Reliability**



Mechanical Data

- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish – Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.096 grams (approximate)

LEFT PIN  RIGHT PIN  BOTTOMSIDE HEAT SINK 

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	45	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	32	V
Average Rectified Output Current (see also Figure 4)	I _O	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	275	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R _{θJS}	—	0.8	°C/W
Thermal Resistance Junction to Ambient Air (Note 2) T _A = 25°C	R _{θJA}	85	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) T _A = 25°C	R _{θJA}	65	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T _A = 25°C	R _{θJA}	50	—	°C/W
Operating Junction Temperature Range V _R ≤ 80% V _{RRM} V _R ≤ 50% V _{RRM}	T _J	-65 to +125 -65 to +150		°C
Storage Temperature Range	T _{STG}	-65 to +150		°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	45	—	—	V	I _R = 600μA
Forward Voltage	V _F	—	0.40 0.45 0.29 0.37	0.45 0.51 0.35 0.43	V	I _F = 5A, T _S = 25°C I _F = 10A, T _S = 25°C I _F = 5A, T _S = 125°C I _F = 10A, T _S = 125°C
Reverse Leakage Current (Note 5)	I _R	—	0.03 10 0.1 65	0.3 25 0.6 150	mA	T _S = 25°C, V _R = 35V T _S = 100°C, V _R = 35V T _S = 25°C, V _R = 45V T _S = 125°C, V _R = 45V

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
 2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 3. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 4. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 5. Short duration pulse test used to minimize self-heating effect.
 6. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 16.0mm x 12.4mm. Anode pad dimensions 4.7mm x 2.7mm.

PowerDI is a registered trademark of Diodes Incorporated.

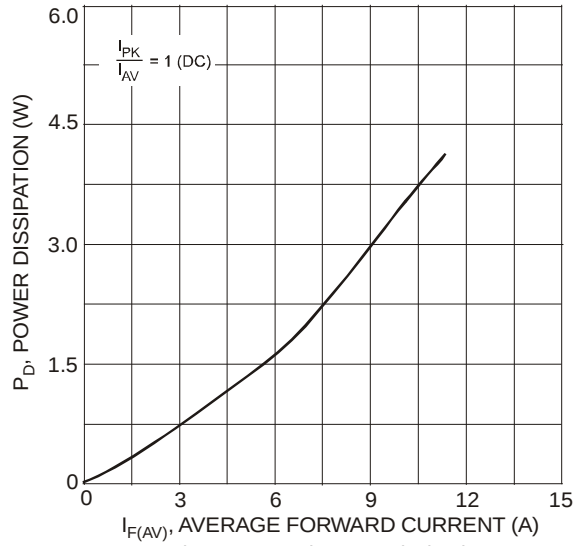


Fig. 1 Forward Power Dissipation

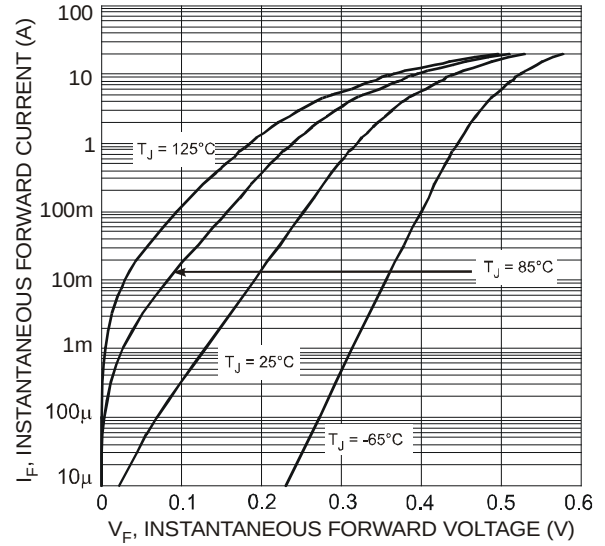


Fig. 2 Typical Forward Characteristics

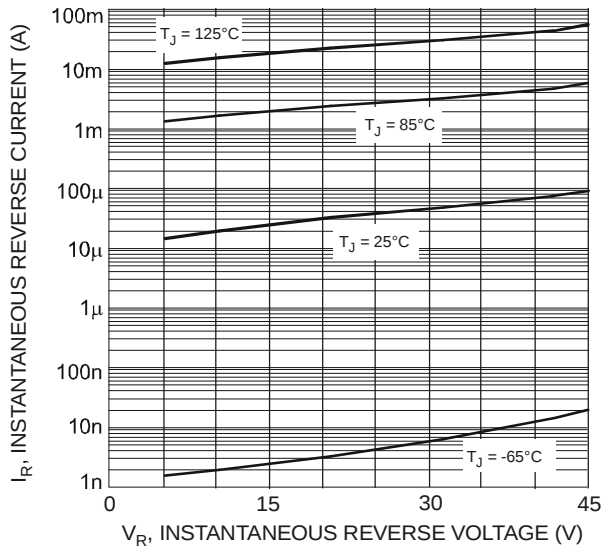


Fig. 3 Typical Reverse Characteristics

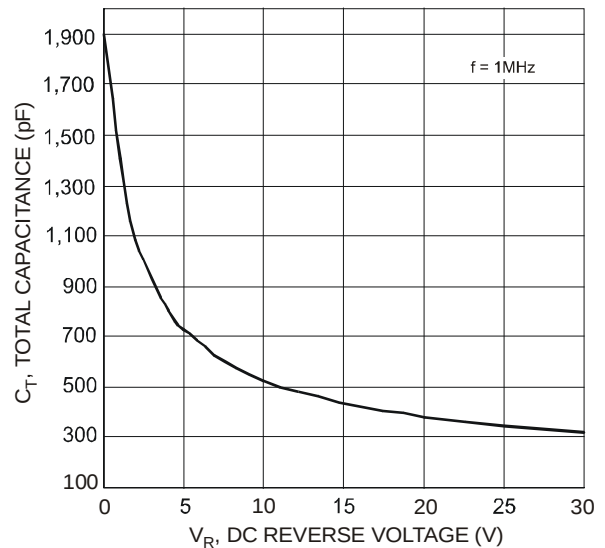


Fig. 4 Total Capacitance vs. Reverse Voltage

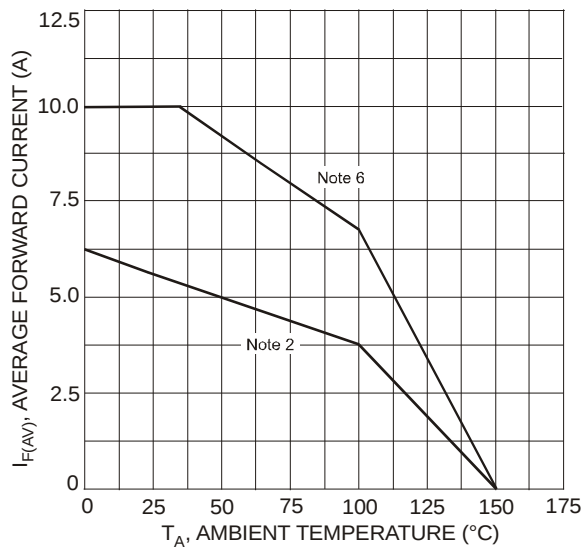


Fig. 5 Forward Current Derating Curve

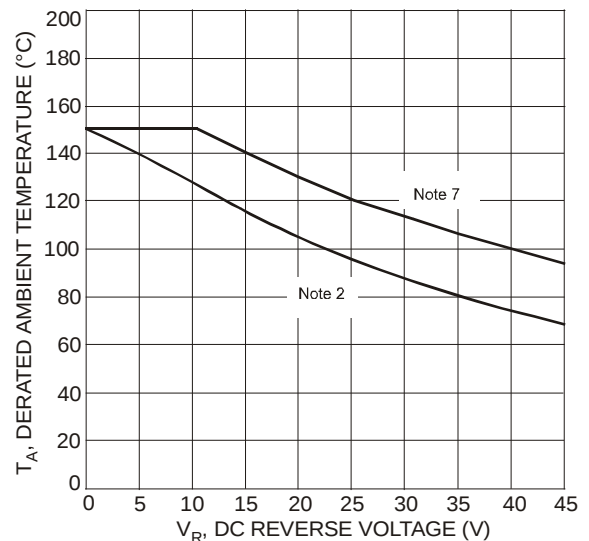


Fig. 6 Operating Temperature Derating

Notes: 7. Devices mounted such that $R_{\theta JA}$ @ 19°C/W .

PowerDI is a registered trademark of Diodes Incorporated.

PDS1045

Document number: DS30539 Rev. 12 - 2

2 of 3

www.diodes.com

May 2008

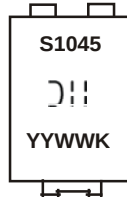
© Diodes Incorporated

Ordering Information (Note 8)

Part Number	Case	Packaging
PDS1045-13	PowerDI [®] 5	5000/Tape & Reel

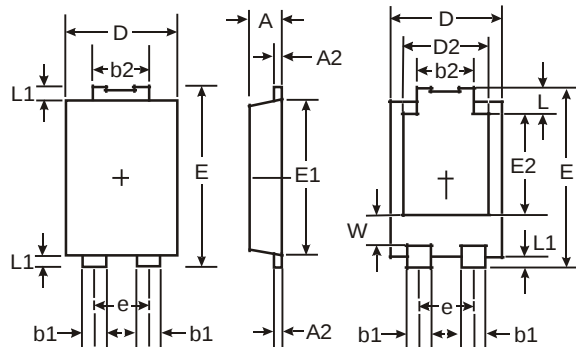
Notes: 8. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



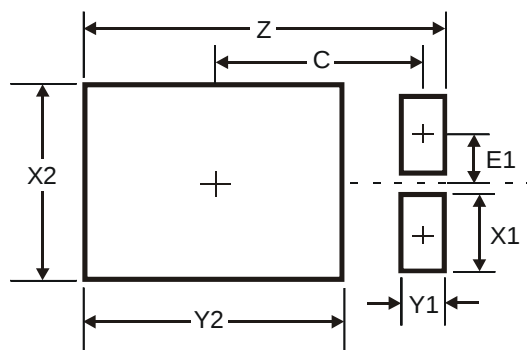
S1045 = Product type marking code
 DII = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last two digits of year ex: 05 for 2005
 WW = Week code 01 to 52
 K = Factory designator

Package Outline Dimensions



PowerDI [®] 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.05	NOM
E	6.40	6.60
e	1.84	NOM
E1	5.30	5.45
E2	3.55	NOM
L	0.75	0.95
L1	0.50	0.65
W	1.20	1.50
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
C	3.87
E1	0.9

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.